# 74LVC1G126

Bus buffer/line driver; 3-state

Rev. 12 — 2 July 2012

**Product data sheet** 

## 1. General description

The 74LVC1G126 provides one non-inverting buffer/line driver with 3-state output. The 3-state output is controlled by the output enable input (OE). A LOW-level at pin OE causes the output to assume a high-impedance OFF-state.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- $\pm$  24 mA output drive (V<sub>CC</sub> = 3.0 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V
- CMOS low power consumption
- Inputs accept voltages up to 5 V
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



# 3. Ordering information

Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
74LVC1G126GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1				
74LVC1G126GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753				
74LVC1G126GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886				
74LVC1G126GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891				
74LVC1G126GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115				
74LVC1G126GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202				
74LVC1G126GX	–40 °C to +125 °C	X2SON5	X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm	SOT1226				

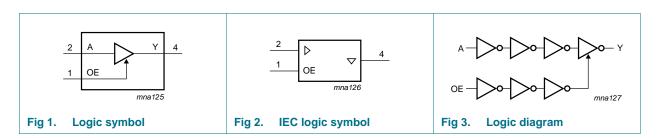
# 4. Marking

Table 2. Marking codes

Type number	Marking <sup>[1]</sup>
74LVC1G126GW	VN
74LVC1G126GV	V26
74LVC1G126GM	VN
74LVC1G126GF	VN
74LVC1G126GN	VN
74LVC1G126GS	VN
74LVC1G126GX	VN

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram



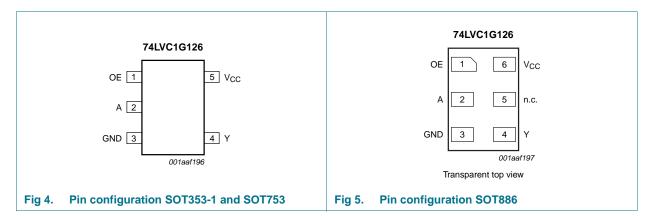
74LVC1G12

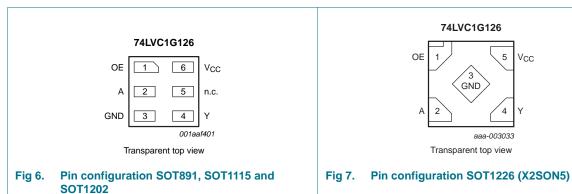
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# 6. Pinning information

### 6.1 Pinning





## 6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	TSSOP5 and X2SON5	XSON6	
OE	1	1	output enable input
A	2	2	data input
GND	3	3	ground (0 V)
Υ	4	4	data output
n.c.	-	5	not connected
V <sub>CC</sub>	5	6	supply voltage

74LVC1G126

# 7. Functional description

Table 4. Function table[1]

Input OE A		Output
OE	A	Υ
Н	L	L
Н	Н	Н
L	X	Z

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

Z = high-impedance OFF-state.

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		=			-
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	Active mode	[ <u>1]</u> [2] -0.5	$V_{CC} + 0.5$	V
		Power-down mode	[ <u>1][2]</u> –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
·			·	·	· ·

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For TSSOP5 and SC-74A packages: above 87.5  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K. For XSON6 and X2SON5 package: above 118  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

# 9. Recommended operating conditions

### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	$V_{CC}$	V
		V <sub>CC</sub> = 0 V; Power-down mode	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	-	-	20	ns/V
		V <sub>CC</sub> = 2.7 V to 5.5 V	-	-	10	ns/V

## 10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$T_{amb} = -$	40 °C to +85 °C					
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC}$ = 1.65 V to 5.5 V; $I_{O}$ = 100 $\mu A$	-	-	0.1	V
		V <sub>CC</sub> = 1.65 V; I <sub>O</sub> = 4 mA	-	-	0.45	V
		$V_{CC} = 2.3 \text{ V}; I_{O} = 8 \text{ mA}$	-	-	0.3	V
		$V_{CC} = 2.7 \text{ V}; I_{O} = 12 \text{ mA}$	-	-	0.4	V
		$V_{CC} = 3.0 \text{ V}; I_{O} = 24 \text{ mA}$	-	-	0.55	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = 32 \text{ mA}$	-	-	0.55	V
$V_{OH}$	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC}$ = 1.65 V to 5.5 V; $I_{O}$ = $-100~\mu A$	$V_{CC}-0.1$	-	-	V
		$V_{CC} = 1.65 \text{ V}; I_{O} = -4 \text{ mA}$	1.2	-	-	V
		$V_{CC} = 2.3 \text{ V; } I_{O} = -8 \text{ mA}$	1.9	-	-	V
		$V_{CC} = 2.7 \text{ V}; I_{O} = -12 \text{ mA}$	2.2	-	-	V
		$V_{CC} = 3.0 \text{ V}; I_{O} = -24 \text{ mA}$	2.3	-	-	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = -32 \text{ mA}$	3.8	-	-	V
I <sub>I</sub>	input leakage current	$V_{CC} = 0 \text{ V to } 5.5 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_{CC} = 3.6 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $V_O = 5.5 \text{ V or GND}$	-	±0.1	±10	μА
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$	-	0.1	10	μΑ
$\Delta I_{CC}$	additional supply current	per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	μА
C <sub>I</sub>	input capacitance		-	5	-	pF

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Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T <sub>amb</sub> = -	40 °C to +125 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC}$ = 1.65 V to 5.5 V; $I_{O}$ = 100 $\mu A$	-	-	0.1	V
		$V_{CC} = 1.65 \text{ V}; I_{O} = 4 \text{ mA}$	-	-	0.70	V
		$V_{CC} = 2.3 \text{ V}; I_{O} = 8 \text{ mA}$	-	-	0.45	V
		$V_{CC} = 2.7 \text{ V}; I_{O} = 12 \text{ mA}$	-	-	0.60	V
		$V_{CC} = 3.0 \text{ V}; I_{O} = 24 \text{ mA}$	-	-	0.80	V
		$V_{CC} = 4.5 \text{ V}; I_{O} = 32 \text{ mA}$	-	-	0.80	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$V_{CC}$ = 1.65 V to 5.5 V; $I_{O}$ = $-100~\mu A$	$V_{CC}-0.1$	-	-	V
		$V_{CC} = 1.65 \text{ V}; I_{O} = -4 \text{ mA}$	0.95	-	-	V
		$V_{CC} = 2.3 \text{ V}; I_{O} = -8 \text{ mA}$	1.7	-	-	V
		$V_{CC} = 2.7 \text{ V}; I_{O} = -12 \text{ mA}$	1.9	-	-	V
		$V_{CC} = 3.0 \text{ V}; I_{O} = -24 \text{ mA}$	2.0	-	-	V
		$V_{CC}$ = 4.5 V; $I_O$ = -32 mA	3.4	-	-	V
I <sub>I</sub>	input leakage current	$V_{CC} = 0 \text{ V to } 5.5 \text{ V}; V_{I} = 5.5 \text{ V or GND}$	-	-	±100	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_{CC} = 3.6 \text{ V}; V_I = V_{IH} \text{ or } V_{IL};$ $V_O = 5.5 \text{ V or GND}$	-	-	±200	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}$ ; $V_I \text{ or } V_O = 5.5 \text{ V}$	-	-	±200	μΑ
I <sub>CC</sub>	supply current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A	-	-	200	μΑ
$\Delta I_{CC}$	additional supply current	per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V};$ $I_{O} = 0 \text{ A}$	-	-	5000	μΑ

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

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# 11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		-40 °C to +85 °C			-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation delay	A to Y; see Figure 8	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	3	8.0	1.0	10.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.1	5.5	0.5	7	ns
		$V_{CC} = 2.7 \text{ V}$		0.5	2.3	5.5	0.5	7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	2.0	4.5	0.5	6	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	1.7	4.0	0.5	5.5	ns
t <sub>en</sub>	enable time	OE to Y; see Figure 9	[3]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	3.2	9.4	1.0	12	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.2	6.6	0.5	8.5	ns
		$V_{CC} = 2.7 \text{ V}$		0.5	2.4	6.6	0.5	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	2.1	5.3	0.5	7	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	1.6	5.0	0.5	6.5	ns
t <sub>dis</sub>	disable time	OE to Y; see Figure 9	[4]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	4.3	9.2	1.0	12	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.7	5.5	0.5	7	ns
		$V_{CC} = 2.7 \text{ V}$		0.5	3.4	5.5	0.5	7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	3.0	5.5	0.5	7	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	2.2	4.2	0.5	5.5	ns
$C_{PD}$	power dissipation	per buffer; $V_I = GND$ to $V_{CC}$	<u>[5]</u>						
	capacitance	output enabled		-	25	-	-	-	pF
		output disabled		-	6	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.8$  V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

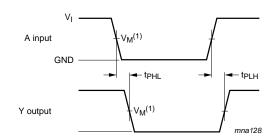
<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

<sup>[3]</sup>  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ 

<sup>[4]</sup> t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>

<sup>[5]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

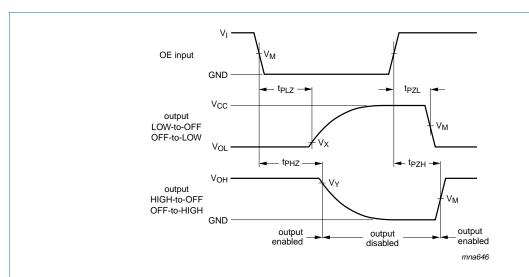
### 12. Waveforms



Measurement points are given in Table 9.

 $\ensuremath{V_{OL}}$  and  $\ensuremath{V_{OH}}$  are typical output voltage levels that occur with the output load.

Fig 8. Input A to output Y propagation delay times



Measurement points are given in Table 9.

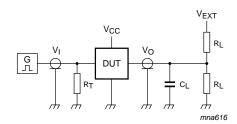
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

Fig 9. 3-state enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output		
Vcc	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
1.65 V to 1.95 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	$V_{OH}-0.15\ V$
2.3 V to 2.7 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V
2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$
3.0 V to 3.6 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH}-0.3\ V$
4.5 V to 5.5 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$

74LVC1G126



Test data is given in  $\underline{\text{Table 10}}$ .

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input	nput		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
1.65 V to 1.95 V	$V_{CC}$	$\leq$ 2.0 ns	30 pF	1 kΩ	open	GND	2V <sub>CC</sub>	
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	30 pF	$500 \Omega$	open	GND	$2V_{CC}$	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	6 V	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V	
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	$2V_{CC}$	

# 13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1

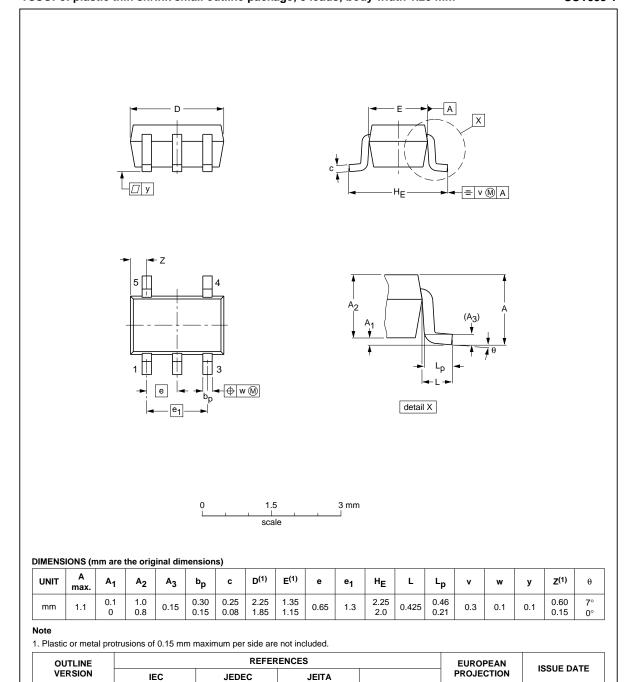


Fig 11. Package outline SOT353-1 (TSSOP5)

SOT353-1

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SC-88A

MO-203

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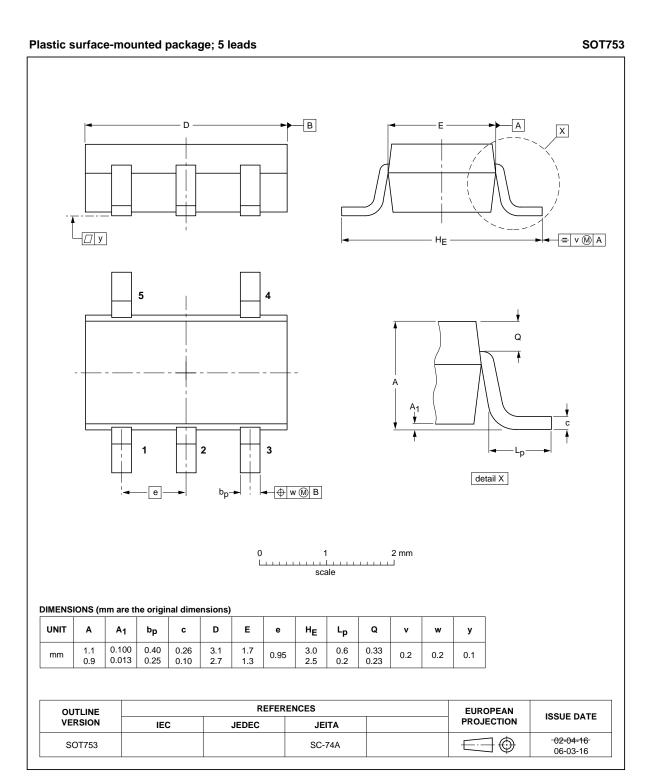


Fig 12. Package outline SOT753 (SC-74A)

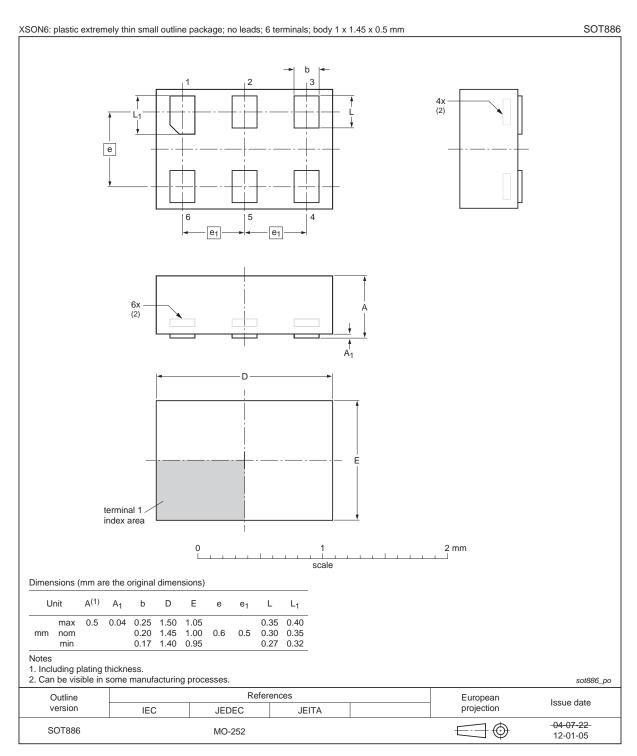


Fig 13. Package outline SOT886 (XSON6)

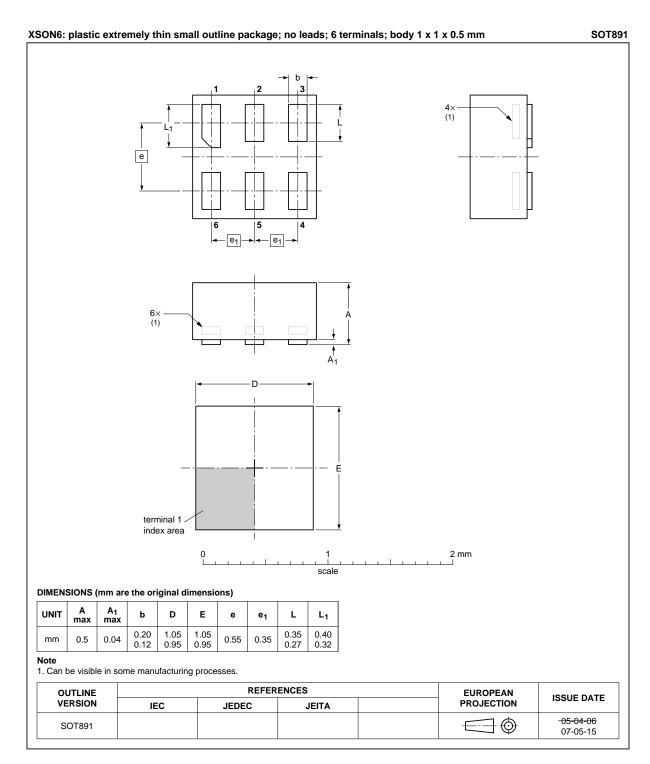


Fig 14. Package outline SOT891 (XSON6)

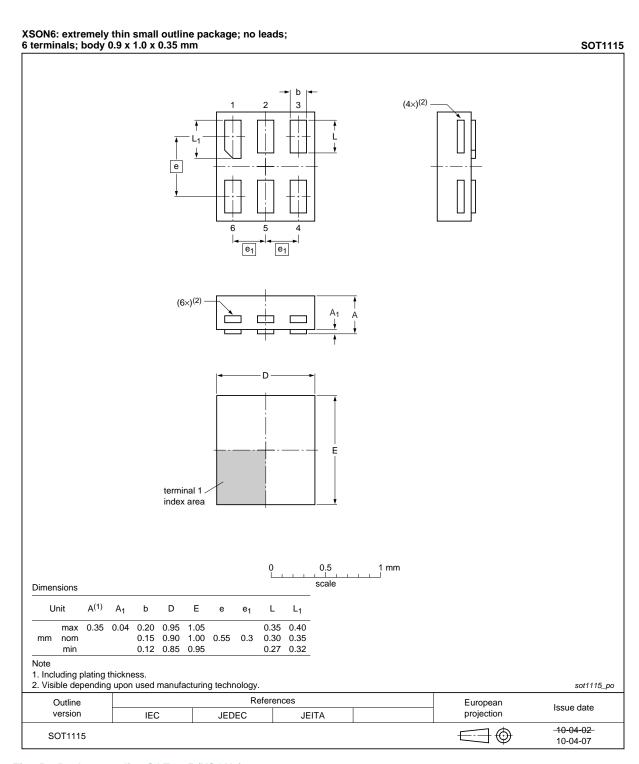


Fig 15. Package outline SOT1115 (XSON6)

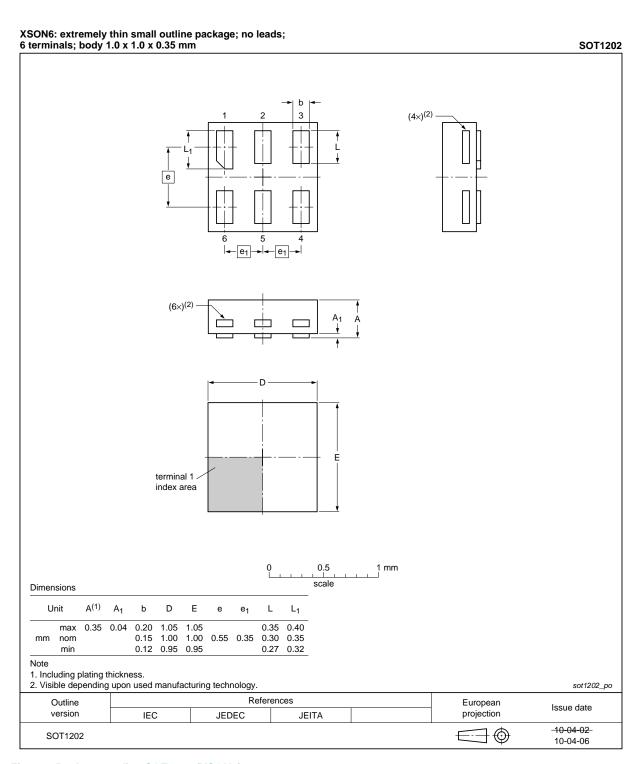


Fig 16. Package outline SOT1202 (XSON6)

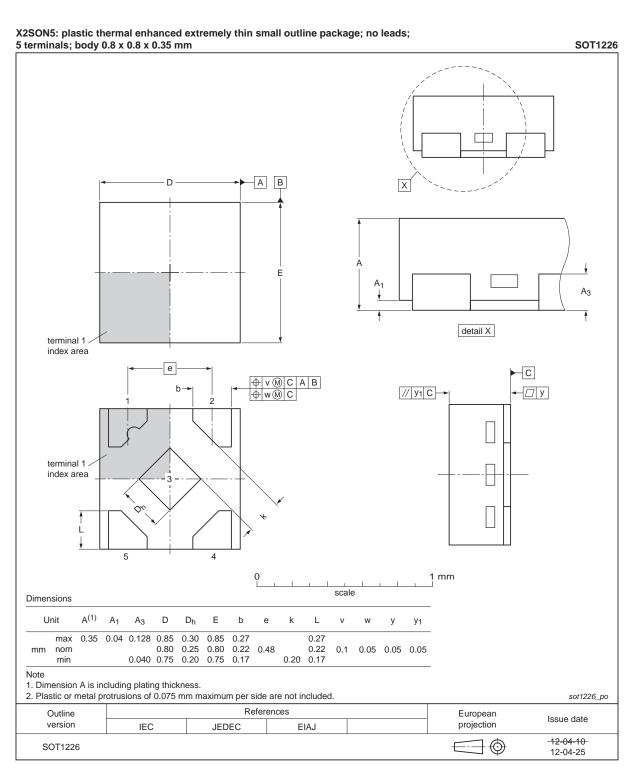


Fig 17. Package outline SOT1226 (X2SON5)

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## 14. Abbreviations

### Table 11. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 15. Revision history

### Table 12. Revision history

Document ID         Release date         Data sheet status         Change notice         Supersedes           74LVC1G126 v.12         20120702         Product data sheet         -         74LVC1G126 v.11           Modifications:         • Added type number 74LVC1G126GX (SOT1226)         • Package outline drawing of SOT886 (Figure 13) modified.           74LVC1G126 v.11         20111208         Product data sheet         -         74LVC1G126 v.10           Modifications:         • Legal pages updated.         -         74LVC1G126 v.9           74LVC1G126 v.10         20101229         Product data sheet         -         74LVC1G126 v.9           74LVC1G126 v.9         20100825         Product data sheet         -         74LVC1G126 v.8           74LVC1G126 v.8         20090409         Product data sheet         -         74LVC1G126 v.7           74LVC1G126 v.7         20070830         Product data sheet         -         74LVC1G126 v.6           74LVC1G126 v.6         20061009         Product specification         -         74LVC1G126 v.5           74LVC1G126 v.4         20021002         Product specification         -         74LVC1G126 v.3           74LVC1G126 v.2         20010406         Preliminary specification         -         74LVC1G126 v.1           74LVC1G126 v.1		- •						
Modifications:       ● Added type number 74LVC1G126GX (SOT1226)         ● Package outline drawing of SOT886 (Figure 13) modified.         74LVC1G126 v.11       20111208       Product data sheet       -       74LVC1G126 v.10         Modifications:       ● Legal pages updated.         74LVC1G126 v.10       20101229       Product data sheet       -       74LVC1G126 v.9         74LVC1G126 v.9       20100825       Product data sheet       -       74LVC1G126 v.8         74LVC1G126 v.8       20090409       Product data sheet       -       74LVC1G126 v.7         74LVC1G126 v.7       20070830       Product data sheet       -       74LVC1G126 v.6         74LVC1G126 v.6       20061009       Product data sheet       -       74LVC1G126 v.5         74LVC1G126 v.5       20040921       Product specification       -       74LVC1G126 v.4         74LVC1G126 v.4       20021002       Product specification       -       74LVC1G126 v.3         74LVC1G126 v.3       20020528       Product specification       -       74LVC1G126 v.2         74LVC1G126 v.2       20010406       Preliminary specification       -       74LVC1G126 v.1	Document ID	Release date	Data sheet status	Change notice	Supersedes			
<ul> <li>Package outline drawing of SOT886 (Figure 13) modified.</li> <li>74LVC1G126 v.11</li> <li>20111208</li> <li>Product data sheet</li> <li>-</li> <li>74LVC1G126 v.10</li> <li>Modifications:</li> <li>Legal pages updated.</li> <li>74LVC1G126 v.9</li> <li>74LVC1G126 v.9</li> <li>74LVC1G126 v.9</li> <li>74LVC1G126 v.8</li> <li>74LVC1G126 v.8</li> <li>74LVC1G126 v.8</li> <li>74LVC1G126 v.7</li> <li>74LVC1G126 v.7</li> <li>74LVC1G126 v.7</li> <li>74LVC1G126 v.6</li> <li>74LVC1G126 v.6</li> <li>74LVC1G126 v.6</li> <li>74LVC1G126 v.5</li> <li>74LVC1G126 v.5</li> <li>74LVC1G126 v.4</li> <li>74LVC1G126 v.4</li> <li>74LVC1G126 v.3</li> <li>74LVC1G126 v.3</li> <li>74LVC1G126 v.3</li> <li>74LVC1G126 v.2</li> <li>74LVC1G126 v.1</li> <li>74LVC1G126 v.2</li> <li>74LVC1G126 v.1</li> </ul>	74LVC1G126 v.12	20120702	Product data sheet	-	74LVC1G126 v.11			
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